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COMPLIANT

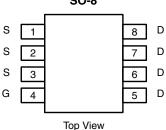
HALOGEN

FREE

**Vishay Siliconix** 

## N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) Max.	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
	0.0042 at V <sub>GS</sub> = 10 V	32.1				
60	0.0054 at V <sub>GS</sub> = 6 V	28.3	18.8 nC			
	0.0069 at $V_{GS}$ = 4.5 V	25				



Si4062DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

**Ordering Information:** 

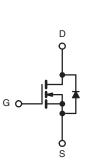
#### SO-8



- TrenchFET<sup>®</sup> Power MOSFET 100 % Rg and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- DC/DC Primary Side Switch
- Industrial
- Synchronous Rectification
- Load Switch
- **DC/DC** Converters
- **DC/AC** Inverters



N-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	60		
Gate-Source Voltage		V <sub>GS</sub>	± 20	V
	T <sub>C</sub> = 25 °C		32.1	
Continuous Drain Current (T 150 °C)	T <sub>C</sub> = 70 °C	1 .	25.7	
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	21.5 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		17 <sup>b, c</sup>	A
Pulsed Drain Current (t = 100 µs)		I <sub>DM</sub>	150	A
Quality of the Durin Divide Quant	T <sub>C</sub> = 25 °C		7	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	3.1 <sup>b, c</sup>	
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	25	
Avalanche Energy		E <sub>AS</sub>	31.2	mJ
	T <sub>C</sub> = 25 °C		7.8	
Maximum Dawar Dissinction	T <sub>C</sub> = 70 °C		5	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.5 <sup>b, c</sup>	VV
	T <sub>A</sub> = 70 °C	1	2.2 <sup>b, c</sup>	
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	29	35	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	13	16	0/10		

Notes:

a. Based on  $T_C = 25$  °C.

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b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 80 °C/W.

For technical questions, contact: pmostechsupport@vishav.com

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## Si4062DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		•					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	60			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			96			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I <sub>D</sub> = 250 μA		- 5.8		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.4		2.6	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
	I <sub>DSS</sub>	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V			1	μA	
Zero Gate Voltage Drain Current		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			А	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0035	0.0042		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 6 V, I <sub>D</sub> = 15 A		0.0043	0.0054	Ω	
		$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		0.0055	0.0069	-	
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		80		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			3175			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1265		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			95			
Total Gate Charge	Q <sub>g</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		40			
				18.8	29	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A		8.9			
Gate-Drain Charge	Q <sub>gd</sub>			3.8			
Output Charge	Q <sub>oss</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V		51.5	80		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.5	2	3	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			52	100		
Rise Time	t <sub>r</sub>	$V_{DD} = 30 \text{ V}, \text{ R}_{L} = 3 \Omega$		105	200	- ns -	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10$ Å, $V_{GEN} = 4.5$ V, $R_g = 1 \Omega$		26	50		
Fall Time	t <sub>f</sub>	1		10	20		
Turn-On Delay Time	t <sub>d(on)</sub>			16	30		
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = 30 V, R <sub>L</sub> = 3 Ω		6	12		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		34	70		
Fall Time	t <sub>f</sub>			8	16		
Drain-Source Body Diode Characteristi							
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			7.1		
Pulse Diode Forward Current (t <sub>p</sub> = 100 μs)	I <sub>SM</sub>				150	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A		0.74	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			46	92	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			44	88	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	I <sub>F</sub> = 5 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C		20			
Reverse Recovery Rise Time	t <sub>b</sub>	1		26		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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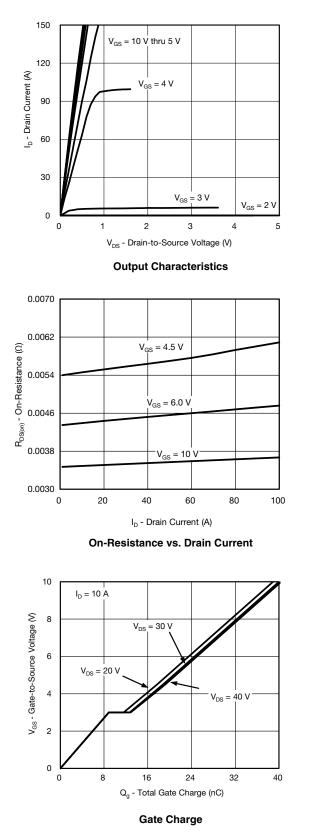
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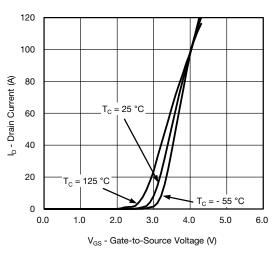
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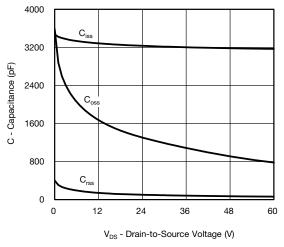
## Si4062DY Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

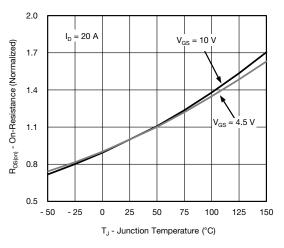




**Transfer Characteristics** 



Capacitance



**On-Resistance vs. Junction Temperature** 

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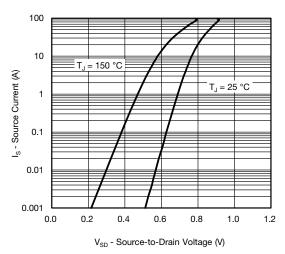
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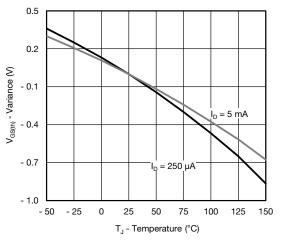
### **Vishay Siliconix**



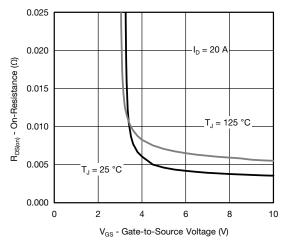
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



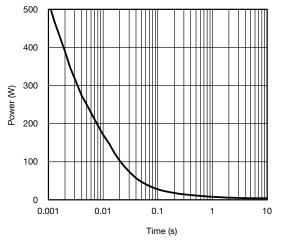




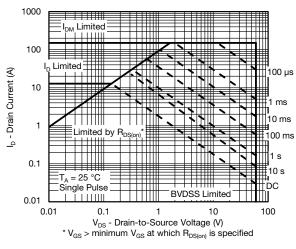
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

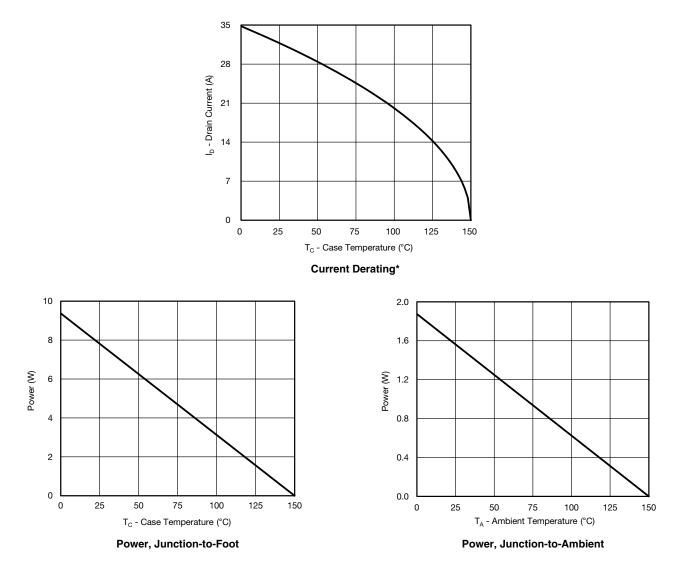
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



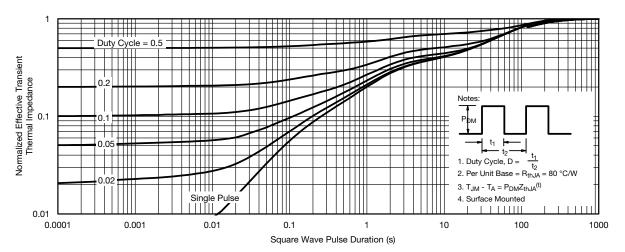
\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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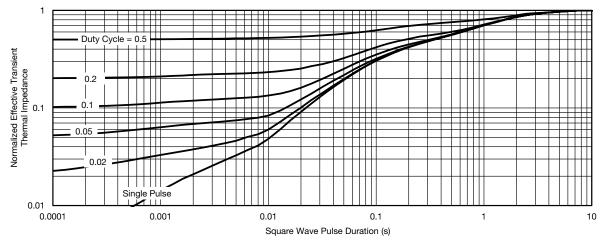


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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg262857">www.vishay.com/ppg262857</a>.

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# Package Information

Vishay Siliconix

# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

## **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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